

### FEATURES

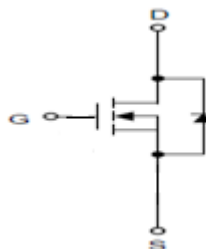
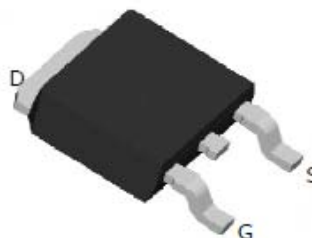
- 30V/60A  
 $R_{DS(ON)} = 9\text{m}\Omega \text{ typ@ } V_{GS}=10\text{V}$   
 $R_{DS(ON)} = 11.5\text{m}\Omega \text{ typ@ } V_{GS}=4.5\text{V}$

- Lead free and Green Device Available

### Application

- Load Switch

### PIN DESCRIPTION



### Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Maximum	Unit	
$V_{DSS}$	Drain-to-Source Voltage	30	V	
$V_{GSS}$	Gate-to-Source Voltage	$\pm 20$	V	
$I_D$	Continuous Drain Current	$T_C=25^\circ\text{C}$	60	A
		$T_C=100^\circ\text{C}$	37	A
$I_{DP}$	Pulsed Drain Current	$T_C=25^\circ\text{C}$	35	A
PD	Maximum Power Dissipation	$T_C=25^\circ\text{C}$	54	W
		$T_C=100^\circ\text{C}$	21	
$T_J, T_{STG}$	Junction & Storage Temperature Range	-55~150	$^\circ\text{C}$	

### Thermal Characteristics

Symbol	Parameter	Typical	Unit
$R_{\theta jc}$	Thermal Resistance-Junction to Case	2.3	$^\circ\text{C}/\text{W}$
$R_{\theta ja}$	Thermal Resistance-Junction to Ambient	62.5	

### Electrical Characteristics (TA=25°C unless otherwise noted)

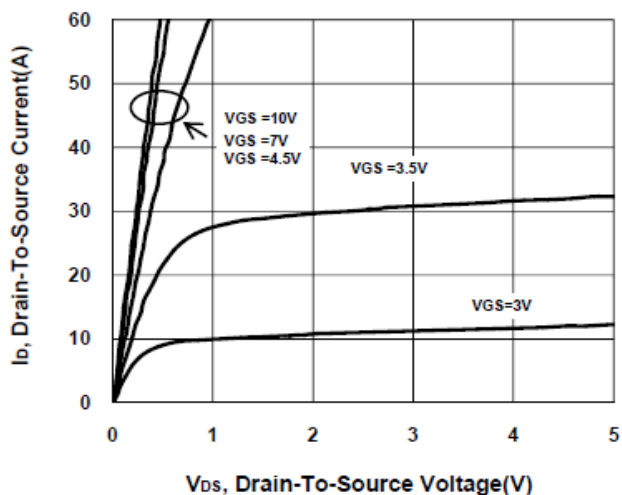
Symbol	Parameter	Test Conditions	Min.	Typ	Max.	Unit
<b>Static Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30	—	—	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=20V, V_{GS}=0V$	—	—	1	uA
		$T_J=85^\circ C$	—	—	10	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1	1.7	3	V
$I_{GSS}$	Gate Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	—	—	$\pm 100$	nA
$R_{DS(on)}^1$	Drain-Source On-Resistance	$V_{GS}=10V, I_D=15A$	—	8.5	10	mΩ
		$V_{GS}=4.5V, I_D=15A$	—	12	15	
<b>Diode Characteristics</b>						
$V_{SD}^1$	Diode Forward Voltage	$I_{SD}=15A, V_{GS}=0V$	—	0.88	1.3	V
$I_S$	Diode Continuous Forward Current				60	A
$t_{rr}$	Reverse Recovery Time	$I_F=15A,$	—	23		ns
$Q_{rr}$	Reverse Recovery Charge	$dI/dt=100A/\mu s$	—	15		nC
<b>Dynamic Characteristics<sup>2</sup></b>						
$R_G$	Gate Resistance	$V_{GS}=0V, V_{DS}=0V,$ Frequency=1MHz	—	1.5	—	Ω
$C_{iss}$	Input Capacitance	$V_{GS}=0V, V_{DS}=30V$ Frequency=1MHz	—	920		pF
$C_{oss}$	Output Capacitance		—	187		
$C_{riss}$	Reverse Transfer Capacitance		—	130		
$t_{d(on)}$	Turn-On Delay Time	$V_{DD}=15V, R_L=30\Omega$ $I_D=15A, V_{GS}=10V$ $R_G=6\Omega$	—	15		ns
$t_r$	Turn-On Rise Time		—	25		
$t_{d(off)}$	Turn-Off Delay Time		—	60		
$t_f$	Turn-Off Fall Time		—	17		
<b>Gate Charge Characteristics<sup>2</sup></b>						
$Q_g$	Total Gate Charge	$V_{DS}=15V, V_{GS}=10V$ $I_D=15A$	—	22		nC
$Q_{gs}$	Gate-to-Source Charge		—	5		
$Q_{gd}$	Gate-to-Drain Charge		—	6.5		

Note: 1: Pulse test; pulse width  $\leq 300ns$ , duty cycle  $\leq 2\%$ .

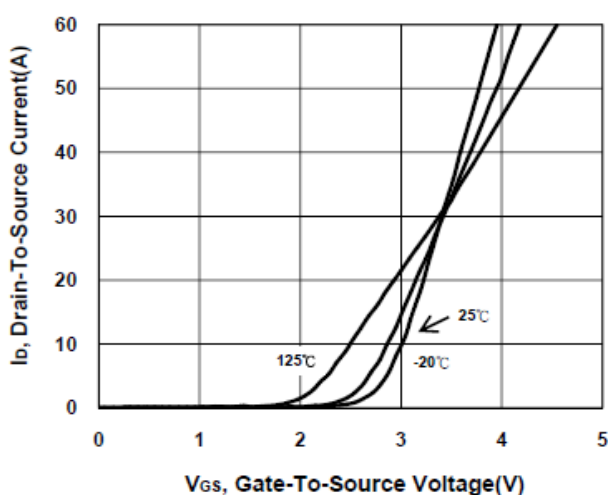
2: Guaranteed by design, not subject to production testing.

## Typical Operating Characteristics

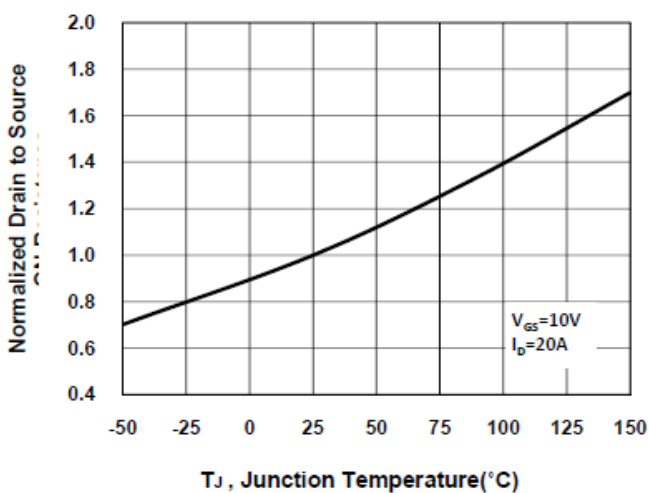
### Output Characteristics



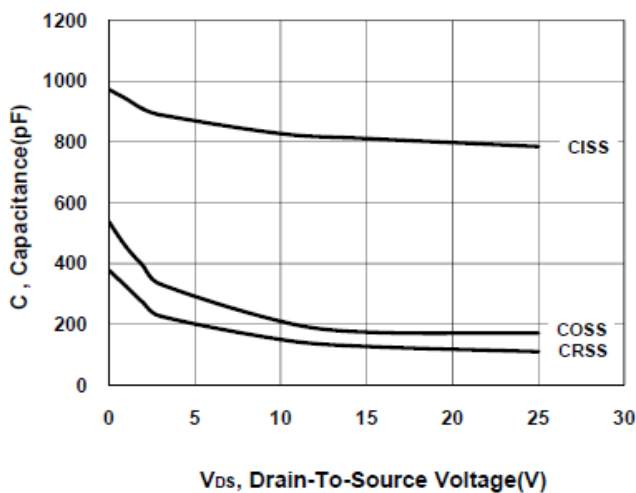
### Transfer Characteristics



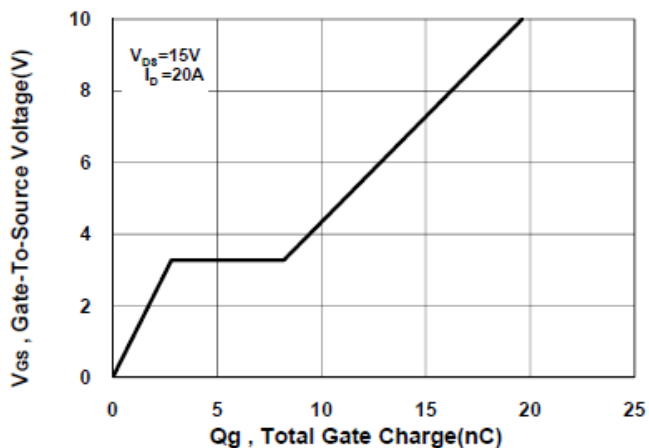
### On-Resistance VS Temperature



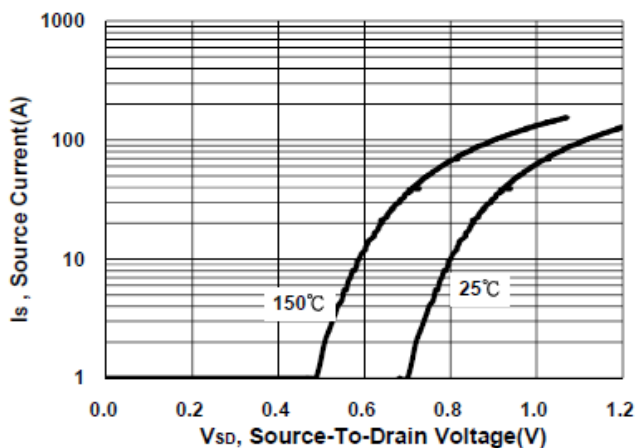
### Capacitance Characteristic



### Gate charge Characteristics

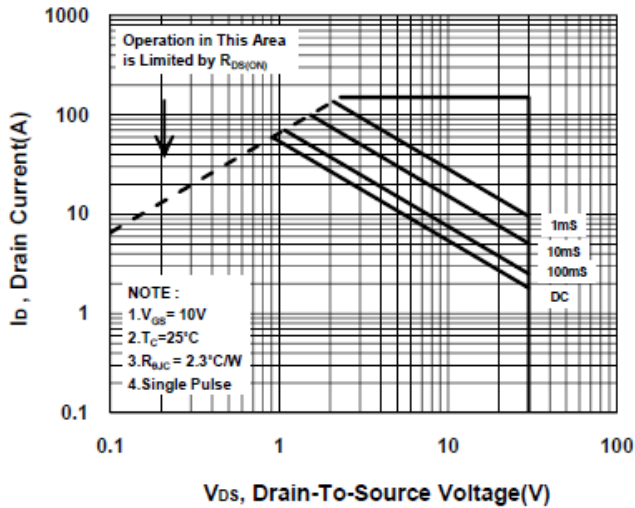


### Source-Drain Diode Forward Voltage

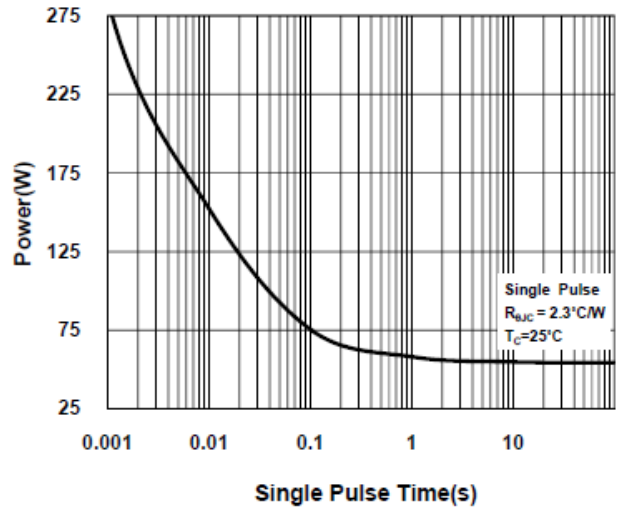


## Typical Operating Characteristics

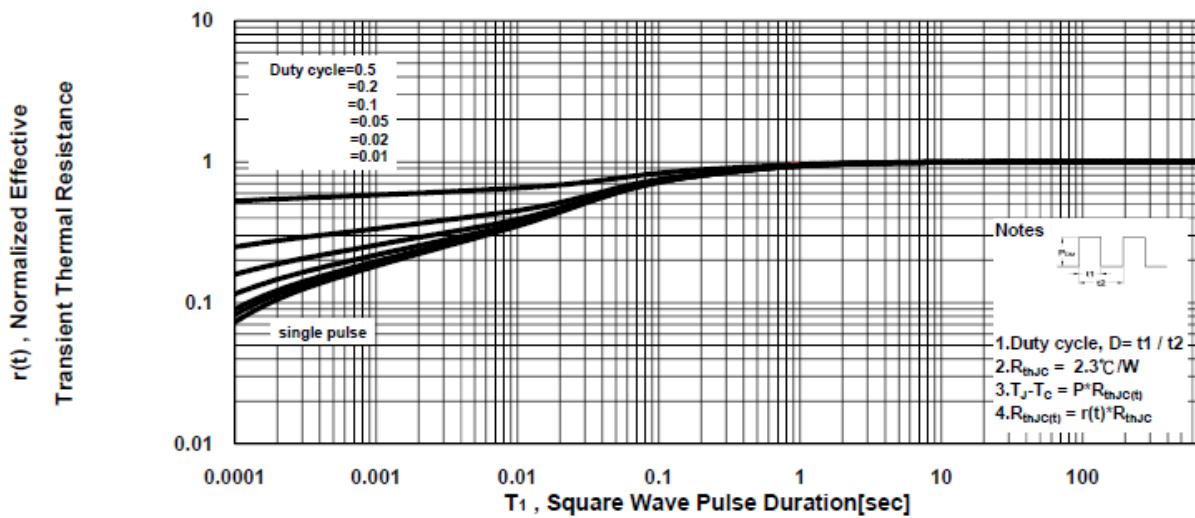
### Safe Operating Area



### Single Pulse Maximum Power Dissipation

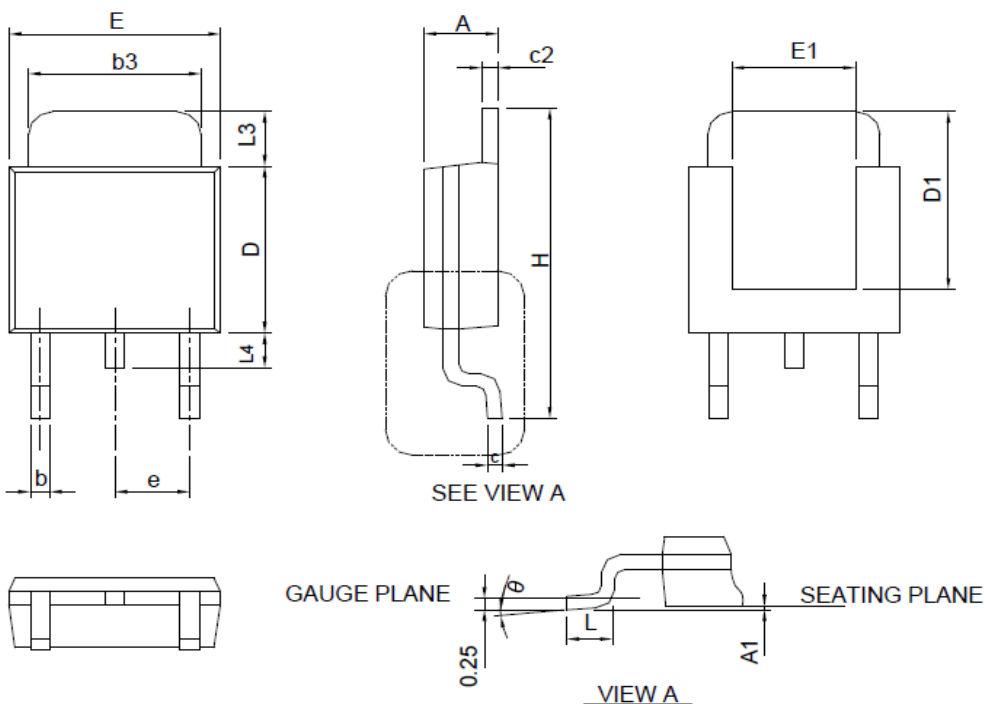


### Transient Thermal Response Curve



### Package Information

TO-252-3



SYMBOL	TO-252-3			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	2.18	2.39	0.086	0.094
A1		0.13		0.005
b	0.50	0.89	0.020	0.035
b3	4.95	5.46	0.195	0.215
c	0.46	0.61	0.018	0.024
c2	0.46	0.89	0.018	0.035
D	5.33	6.22	0.210	0.245
D1	4.57	6.00	0.180	0.236
E	6.35	6.73	0.250	0.265
E1	3.81	6.00	0.150	0.236
e	2.29 BSC		0.090 BSC	
H	9.40	10.41	0.370	0.410
L	0.90	1.78	0.035	0.070
L3	0.89	2.03	0.035	0.080
L4		1.02		0.040
θ	0°	8°	0°	8°

Note : Follow JEDEC TO-252 .